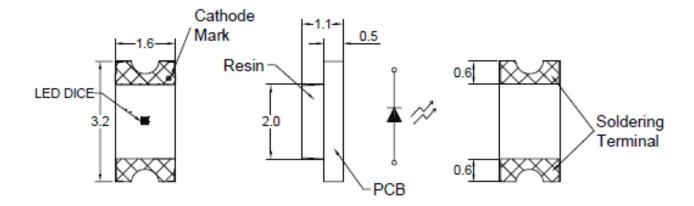


3.2 x 1.6 x 1.1 mm Red SMD LED

PACKAGE DIMENSION



NOTES:

- 1.All dimension are in millimeter tolerance is ± 0.1 mm unless otherwise noted.
- 2. Specifications are subject to change without notice.

Recommended Solder Pad



Note : The tolerances unless mentioned is $\pm 0.1 mm, Angle \pm 0.5.$ Unit=mm.

| Chip Material | Chip Emitted | Lens Color | Viewing Angle |
|---------------|--------------|-------------|---------------|
| AlGalnP | Red | Water Clear | 140 |

Version 1.0 Date: 08-18-2011



3.2 x 1.6 x 1.1 mm Red SMD LED

ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

| Parameter | Symbol | Value | Unit |
|---|------------------|-------------------------|------|
| Forward current | If | 30 | mA |
| Reverse current @ 5V | Ir | 10 | μΑ |
| Power dissipation | Pd | 72 | mW |
| Operating temperature range | Topr | -40~+85 | °C |
| Storage temperature range | Tstg | -40~+90 | °C |
| Peak pulsing current (1/10 duty f= 10KHz) | lfp | 90 | mA |
| Soldering Temperature | T _{SOL} | Max 260°C for 5 sec Max | |

TYPICAL & OPTICAL-ELECTRICAL CHARACTERISTICS (Ta=25°C)

| D | 0 | T . 0 . Evi | Value | | 11. % | |
|-----------------------------|--------|-----------------------|-------|-----|-------|------|
| Parameter | Symbol | Test Condition | Min | Тур | Max | Unit |
| Wavelength at peak emission | λpeak | I _F = 20mA | - | 642 | - | nm |
| Spectral half bandwidth | Δλ | I _F = 20mA | - | 20 | 1 | nm |
| Dominant wavelength | λD | I _F = 20mA | - | 630 | | nm |
| Forward Voltage | Vf | I _F = 20mA | 1.5 | ı | 2.4 | V |
| Luminous intensity | lv | I _F = 20mA | 32 | 80 | 1 | mcd |
| Viewing angle at 50% lv | 20 ½ | I _F = 20mA | - | 140 | | Deg |

Note : 1.The forward voltage data did not including $\pm 0.1V$ testing tolerance.

^{2.} The luminous intensity data did not including $\pm 15\%$ testing tolerance.



3.2 x 1.6 x 1.1 mm Red SMD LED

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES

Fig.1 Forward current vs. Forward Voltage

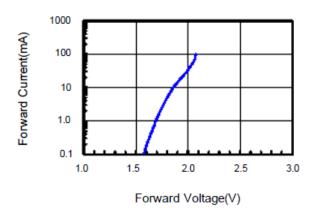


Fig.2 Relative Intensity vs. Forward Current

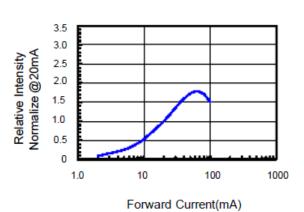


Fig.3 Forward Voltage vs. Temperature

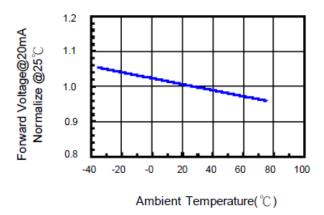


Fig.4 Relative Intensity vs. Temperature

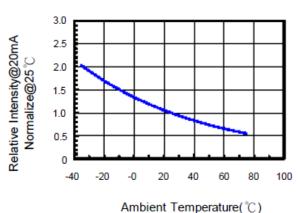


Fig.5 Relative Intensity vs. Wavelength

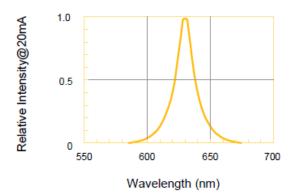
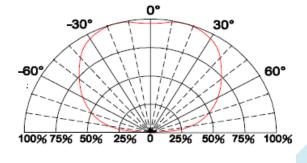


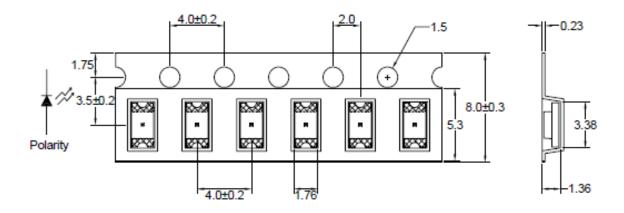
Fig.6 Directive Radiation





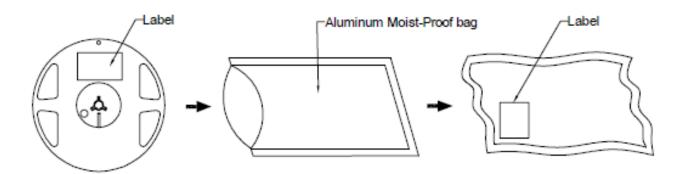
3.2 x 1.6 x 1.1 mm Red SMD LED

Dimensions of Tape (Unit: mm)



Note : The tolerances unless mentioned is ± 0.1 mm, Angle ± 0.5 . Unit=mm.

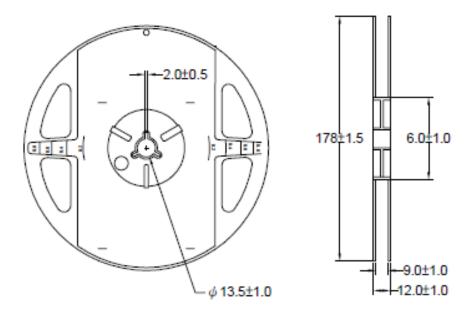
PACKAGING SPECIFICATION





3.2 x 1.6 x 1.1 mm Red SMD LED

REEL DIMENSIONS



Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole.
- 4. 3,000pcs/Reel



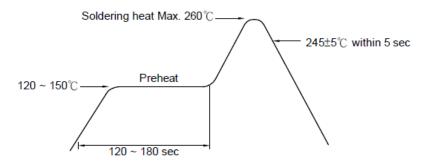
3.2 x 1.6 x 1.1 mm Red SMD LED

Recommended Soldering Conditions

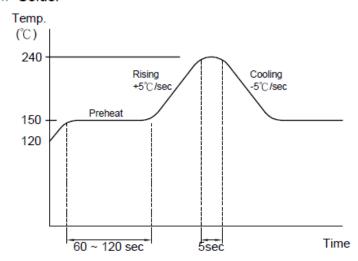
Hand Solder

Basic spec is $\leq 280^{\circ}$ C 3 sec one time only.

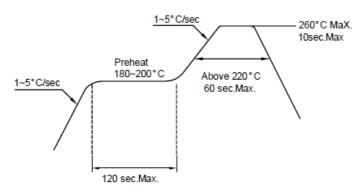
2. Wave Solder



3-1. LEAD Reflow Solder



3-2 PB-Free Reflow Solder



Reflow Soldering should not be done more than two times.



3.2 x 1.6 x 1.1 mm Red SMD LED

Precautions For Use:

Storage time:

- 1. The operation of Temperatures and RH are : 5 °C ~35°C ,RH60%.
- 2.Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with descanting agent. Considering the tape life, we suggest our customers to use our products within a year(from production date).
- 3.If opened more than one week in an atmosphere 5 $^{\circ}$ C \sim 35 $^{\circ}$ C,RH60%, they should be treated at 60 $^{\circ}$ C±5 $^{\circ}$ C fo r 15hrs.

Drive Method:

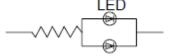
LED is a current operated device, and therefore, requirer some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in series with the LED.

Consider worst case voltage variations than could occur across the current limiting resistor. The forwrd current should not be allowed to change by more than 40 % of its desired value.

Circuit model A







- (A) Recommended circuit.
- (B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

ESD(Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing these LED. All devices, equipment and machinery must be properly grounded.



3.2 x 1.6 x 1.1 mm Red SMD LED

RELIABILITY TEST

| Classification | Test Item | Test Condition | Reference Standard | |
|-----------------------|---|---|---|--|
| Endurance Test | Operating Life Test | 1.Ta=Under Room Temperature As Per Data Sheet Maximum Rating. 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs) | MIL-STD-750D: 1026 MIL-STD-883D: 1005 JIS C 7021: B-1 | |
| | High Temperature Storage Test | 1.Ta=105°C±5°C 2.t=1000 hrs (-24hrs, +72hrs) | MIL-STD-883D:1008 JIS C 7021: B-10 | |
| | Low Temperature Storage Test | 1.Ta=-40°C±5°C 2.t=1000 hrs (-24hrs, +72hrs) | JIS C 7021: B-12 | |
| | High Temperature High Humidity Storage Test | 1.Ta=65°C±5°C 2.RH=90%~95% 3.t=1000hrs±2hrs | MIL-STD-202F:103B JIS C 7021: B-11 | |
| Environmental Test | Thermal Shock Test | 1.Ta=105°C±5°C &-40°C±5°C (10min) (10min) 2.total 10 cycles | MIL-STD-202F: 107D MIL-STD-750D: 1051 MIL-STD-883D: 1011 | |
| | Solderability Test | 1.T.Sol=235°C±5°C 2.Immersion time 2±0.5sec 3.Coverage ≥95% of the dipped surface | MIL-STD-202F: 208D MIL-STD-750D: 2026 MIL-STD-883D: 2003 IEC 68 Part 2-20 JIS C 7021: A-2 | |
| | Temperature Cycling | 1.105°C ~ 25°C ~ -55°C ~ 25°C 30mins 5mins 30mins 5mins 2.10 Cyeles | MIL-STD-202F: 107D MIL-STD-750D: 1051 MIL-STD-883D: 1010 JIS C 7021: A-4 | |
| | IR Reflow | 1.T=260°C Max. 10sec.Max. 2. 6 Min | MIL-STD-750D:2031.2 J-STD-020 | |